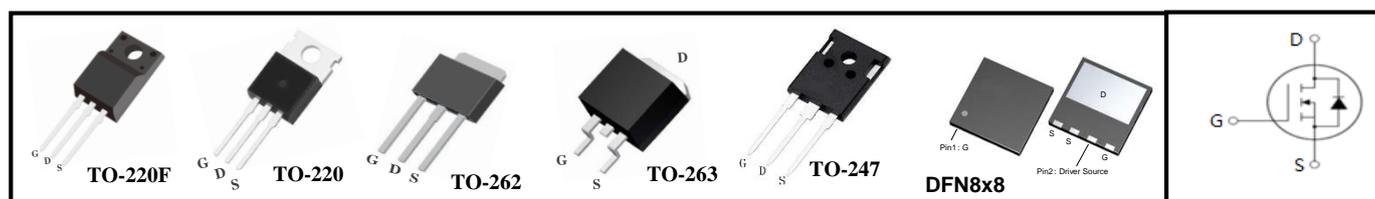


## FEATURES

- $BV_{DSS}=650V$ ,  $I_D=22A$
- $R_{DS(on)}:0.17\Omega(\text{Max})@V_{GS}=10V$
- Very low FOM  $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- RoHS compliant

## APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



## Device Marking and Package Information

Ordering code	Package	Marking
WTM22N65AF	TO-220F	WPM 22N65AF XX YYWW
WTM22N65AP	TO-220	WPM 22N65AP XX YYWW
WTM22N65AZ	TO-262	WPM 22N65AZ XX YYWW
WTM22N65AT	TO-263	WPM 22N65AT XX YYWW
WTM22N65AMP	TO-247	WPM 22N65AMP XX YYWW
WTM22N65AGF	DFN 8*8	WPM 22N65AGF XX YYWW

## Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Value		Unit
		TO-220F	TO-220, TO-263, TO-262, TO-247, DFN 8*8	
Drain-Source Voltage ( $V_{GS} = 0V$ )	$V_{DSS}$	650		V
Continuous Drain Current	$I_D$	22		A
Pulsed Drain Current (note1)	$I_{DM}$	60		A
Gate-Source Voltage	$V_{GSS}$	$\pm 30$		V
Single Pulse Avalanche Energy (note2)	$E_{AS}$	480		mJ
Avalanche Current (note1)	$I_{AR}$	3.5		A
Repetitive Avalanche Energy (note1)	$E_{AR}$	0.7		mJ
MOSFET dv/dt ruggedness, $V_{DS}=0\dots 400V$	dv/dt	50		V/ns
Reverse diode dv/dt, $V_{DS}=0\dots 400V$ , $I_{SD} \leq I_D$	dv/dt	50		V/ns
Power Dissipation ( $T_C = 25^\circ\text{C}$ )	$P_D$	34	150	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~+150		$^\circ\text{C}$

## Thermal Resistance

Parameter	Symbol	Value		Unit
		TO-220F	TO-220, TO-262, TO-263, TO-247, DFN 8*8	
Thermal Resistance, Junction-to-Case	$R_{thJC}$	4	0.83	K/W
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	80	62	

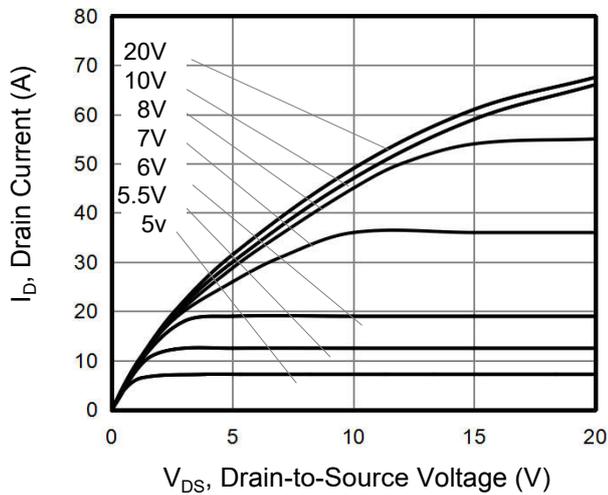
Specifications $T_J = 25^\circ\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	650	--	--	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 650V, V_{GS} = 0V, T_J = 25^\circ\text{C}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 650V, V_{GS} = 0V, T_J = 150^\circ\text{C}$	--	--	100	
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 30V$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 0.25\text{mA}$	2.5	--	3.5	V
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A$	--	0.14	0.17	$\Omega$
Gate Resistance	$R_G$	$f = 1.0\text{MHz}$ , open drain	--	8	--	$\Omega$
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V,$ $V_{DS} = 100V,$ $f = 1.0\text{MHz}$	--	1724	--	$\mu\text{F}$
Output Capacitance	$C_{oss}$		--	72	--	
Reverse Transfer Capacitance	$C_{rss}$		--	6	--	
Total Gate Charge	$Q_g$	$V_{DD} = 400V, I_D = 22A,$ $V_{GS} = 10V$	--	38.5	--	nC
Gate-Source Charge	$Q_{gs}$		--	8	--	
Gate-Drain Charge	$Q_{gd}$		--	15	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=400V, I_D=22A,$ $V_{GS}=10V, R_G=25\Omega$	--	25	--	ns
Turn-on Rise Time	$t_r$		--	59	--	
Turn-off Delay Time	$t_{d(off)}$		--	121	--	
Turn-off Fall Time	$t_f$		--	44	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	22	A
Pulsed Diode Forward Current	$I_{SM}$		--	--	60	
Body Diode Voltage	$V_{SD}$	$T_J = 25^\circ\text{C}, I_{SD} = 22A, V_{GS} = 0V$	--	0.9	1.2	V
Reverse Recovery Time	$t_{rr}$	$V_R = 400V, I_F = 22A,$ $di_F/dt = 100A/\mu\text{s}$	--	453	--	ns
Reverse Recovery Charge	$Q_{rr}$		--	5.1	--	$\mu\text{C}$
Peak Reverse Recovery Current	$I_{rrm}$		--	22	--	A

#### Notes

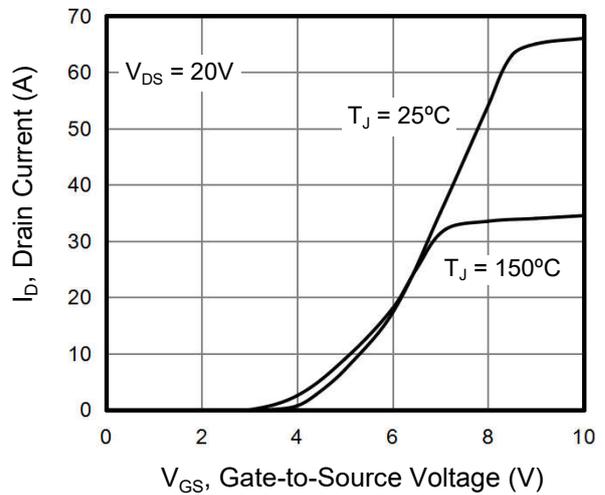
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2.  $I_{AS} = 3.5A, V_{DD} = 50V, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$
3. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 1\%$

**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

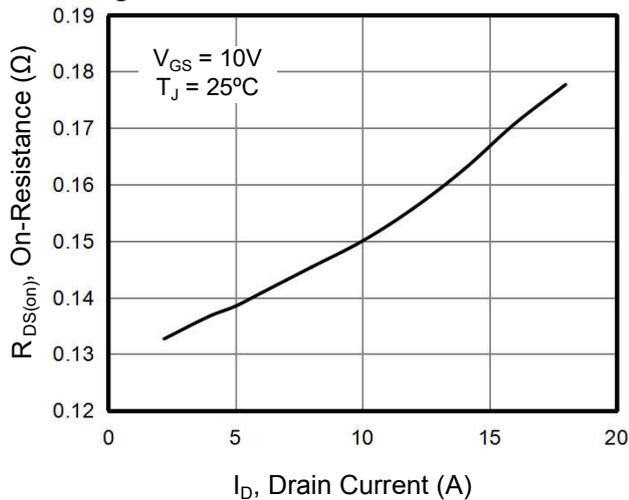
**Figure 1. Output Characteristics**



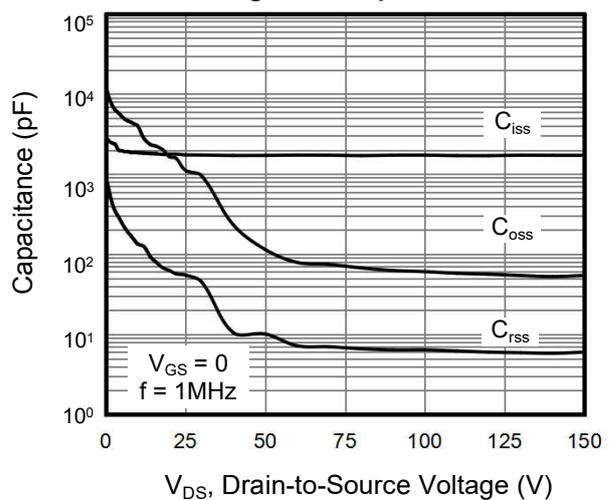
**Figure 2. Transfer Characteristics**



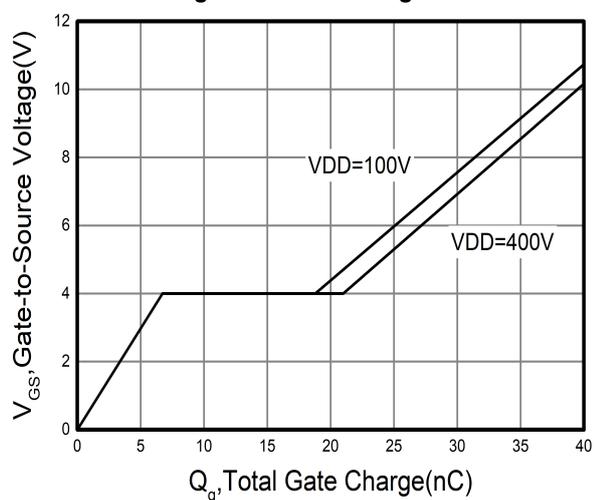
**Figure 3. On-Resistance vs. Drain Current**



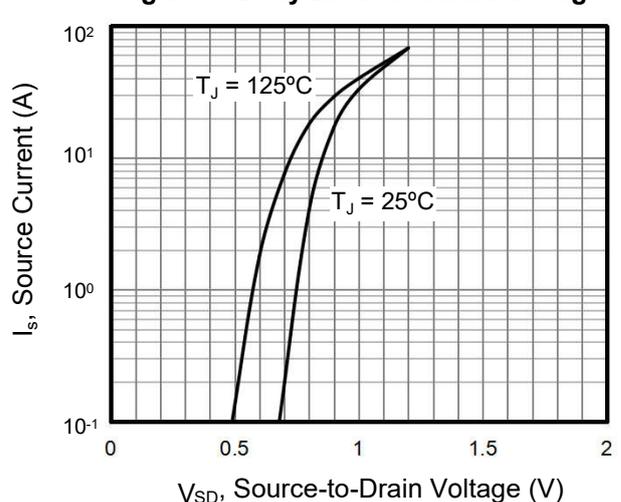
**Figure 4. Capacitance**



**Figure 5. Gate Charge**

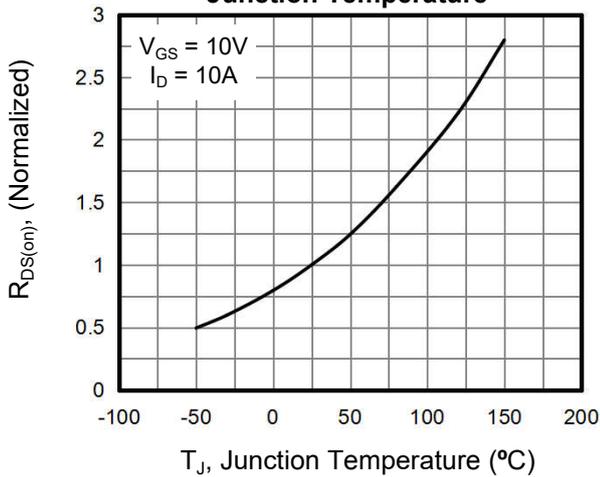


**Figure 6. Body Diode Forward Voltage**

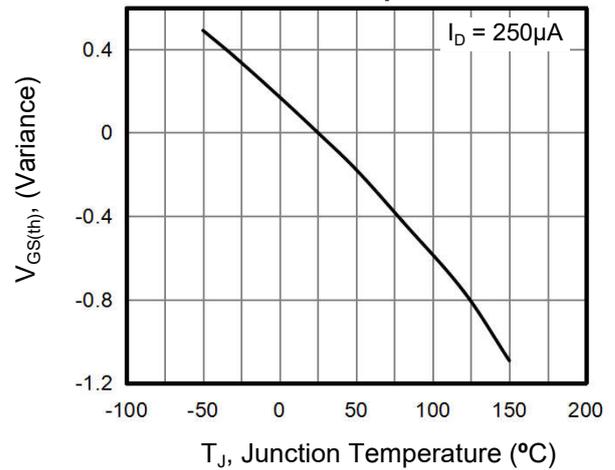


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

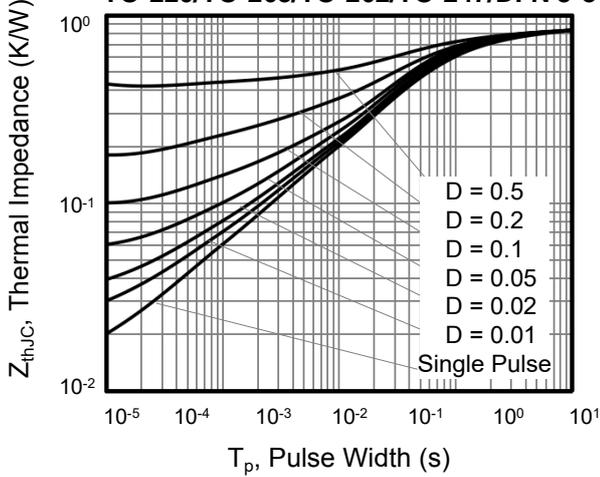
**Figure 7. On-Resistance vs. Junction Temperature**



**Figure 8. Threshold Voltage vs. Junction Temperature**



**Figure 9. Transient Thermal Impedance TO-220/TO-263/TO-262/TO-247/DFN 8\*8**



**Figure 10. Transient Thermal Impedance TO-220F**

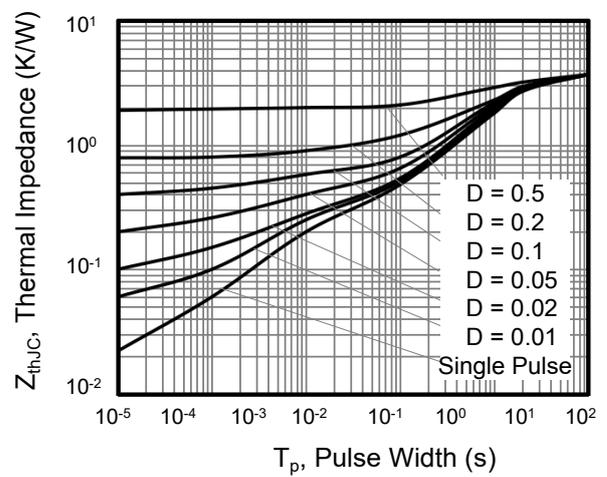


Figure A: Gate Charge Test Circuit and Waveform

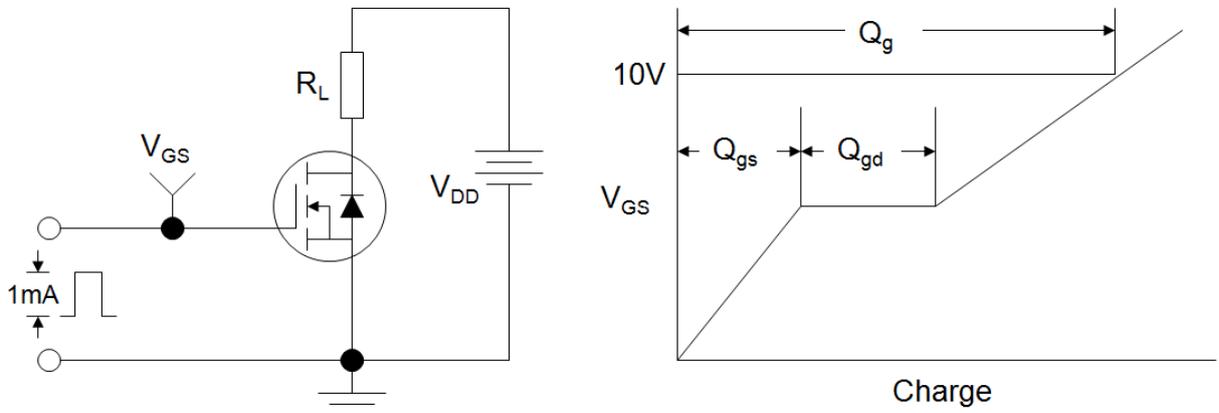


Figure B: Resistive Switching Test Circuit and Waveform

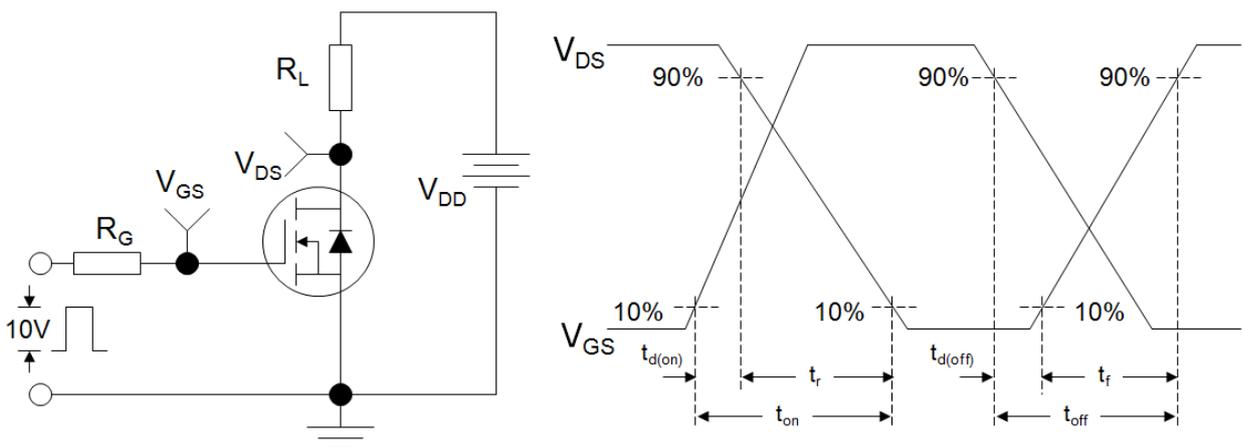
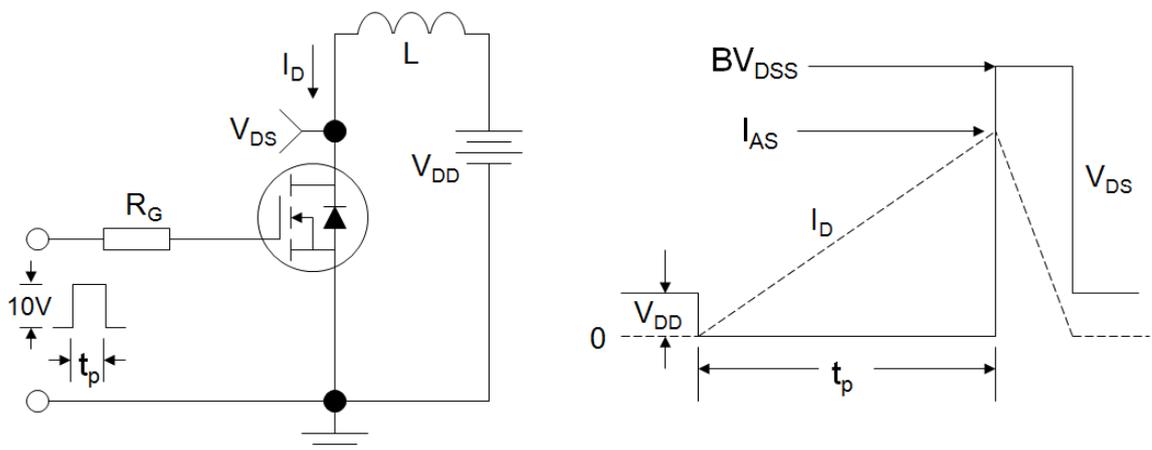
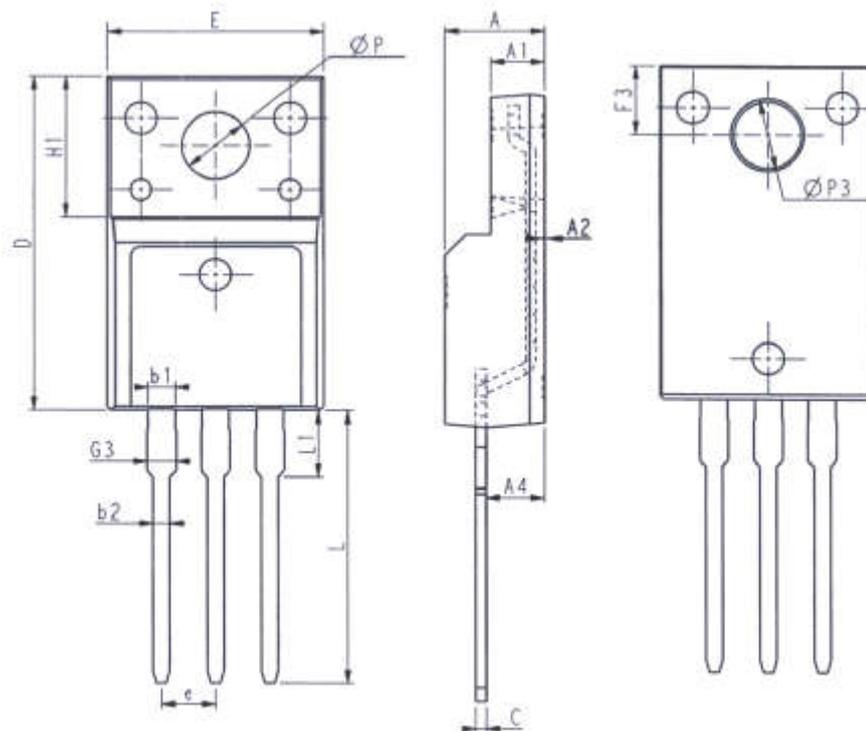


Figure C: Unclamped Inductive Switching Test Circuit and Waveform

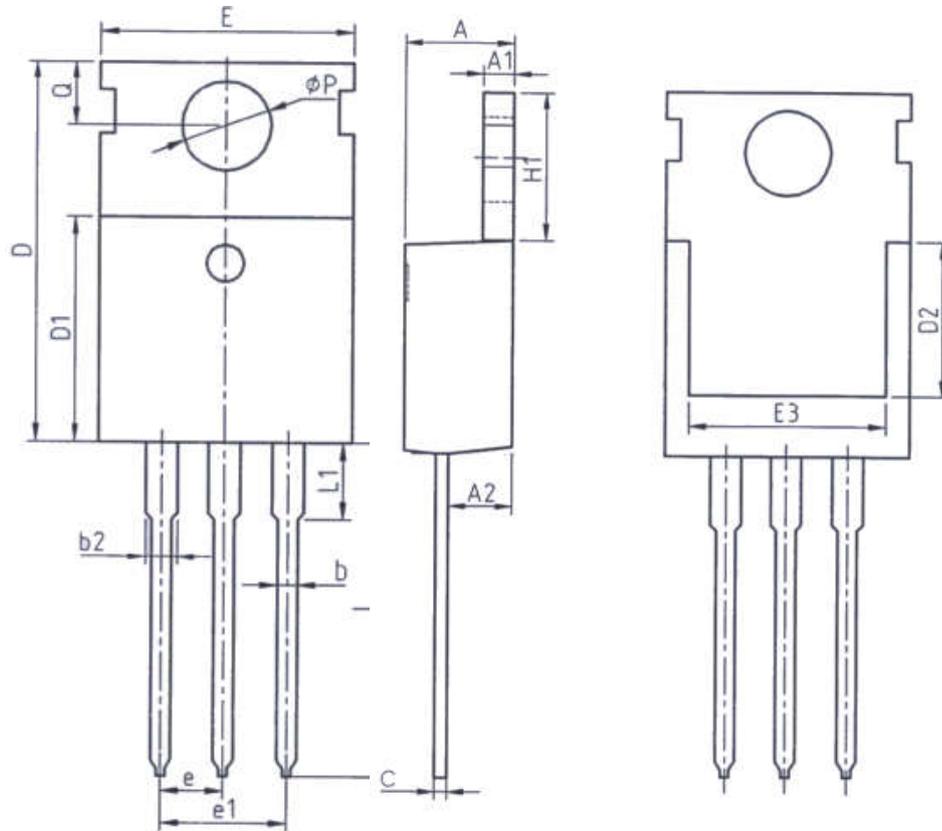


## TO-220F



Unit: mm			Unit: mm		
Symbol	Min.	Max.	Symbol	Min.	Max.
E	9.96	10.36	L	12.68	13.28
A	4.50	4.90	L1	2.93	3.13
A1	2.34	2.74	P	3.03	3.38
A2	0.30	0.60	P3	3.15	3.65
A4	2.56	2.96	F3	3.15	3.45
c	0.40	0.65	G3	1.25	1.55
D	15.57	16.17	b1	1.18	1.43
H1	6.70REF		b2	0.70	0.95
e	2.54BSC				

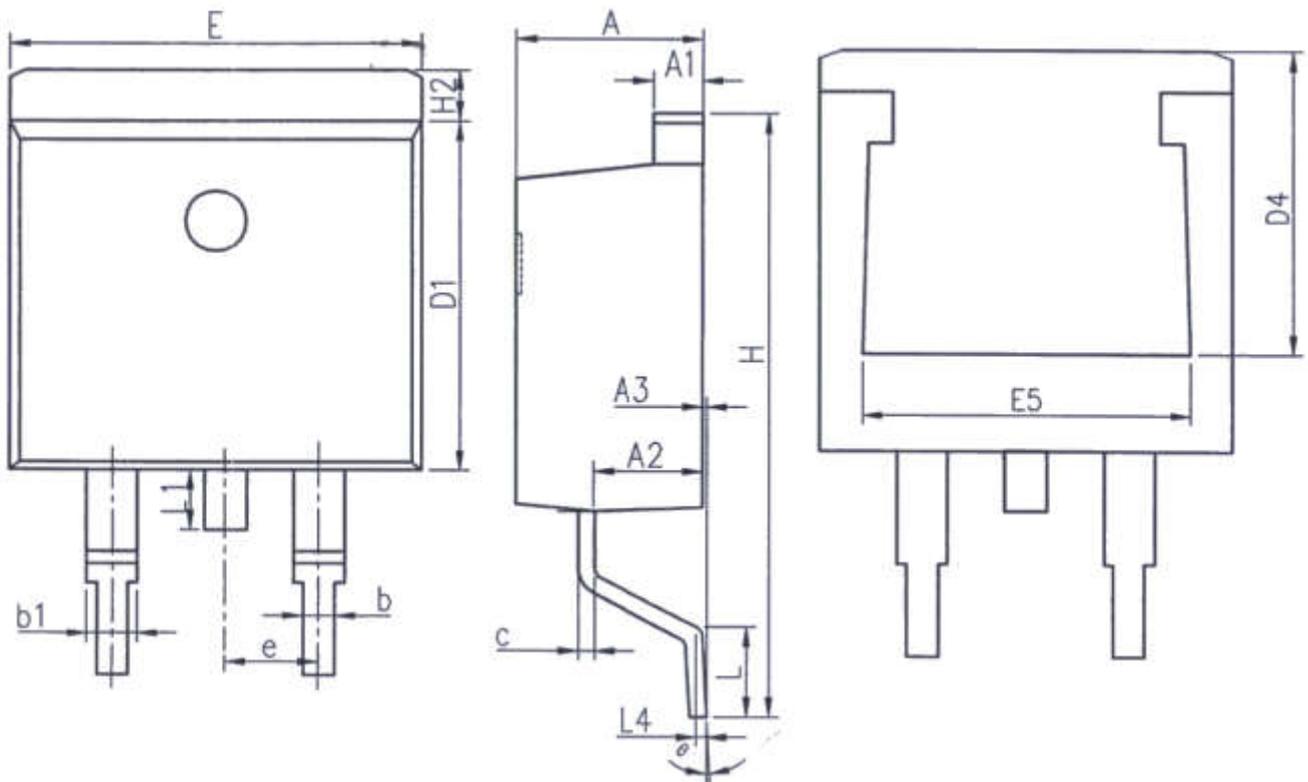
## TO-220



Unit: mm		
Symbol	Min.	Max.
A	4.37	4.77
A1	1.25	1.45
A2	2.20	2.60
b	0.70	0.95
b2	1.17	1.47
c	0.40	0.65
D	15.10	16.10
D1	8.80	9.40
D2	5.50	-

Unit: mm		
Symbol	Min.	Max.
E	9.70	10.30
E3	7.00	-
e	2.54BSC	
e1	5.08BSC	
H1	6.25	6.85
L	12.75	13.80
L1	-	3.40
P	3.40	3.80
Q	2.60	3.00

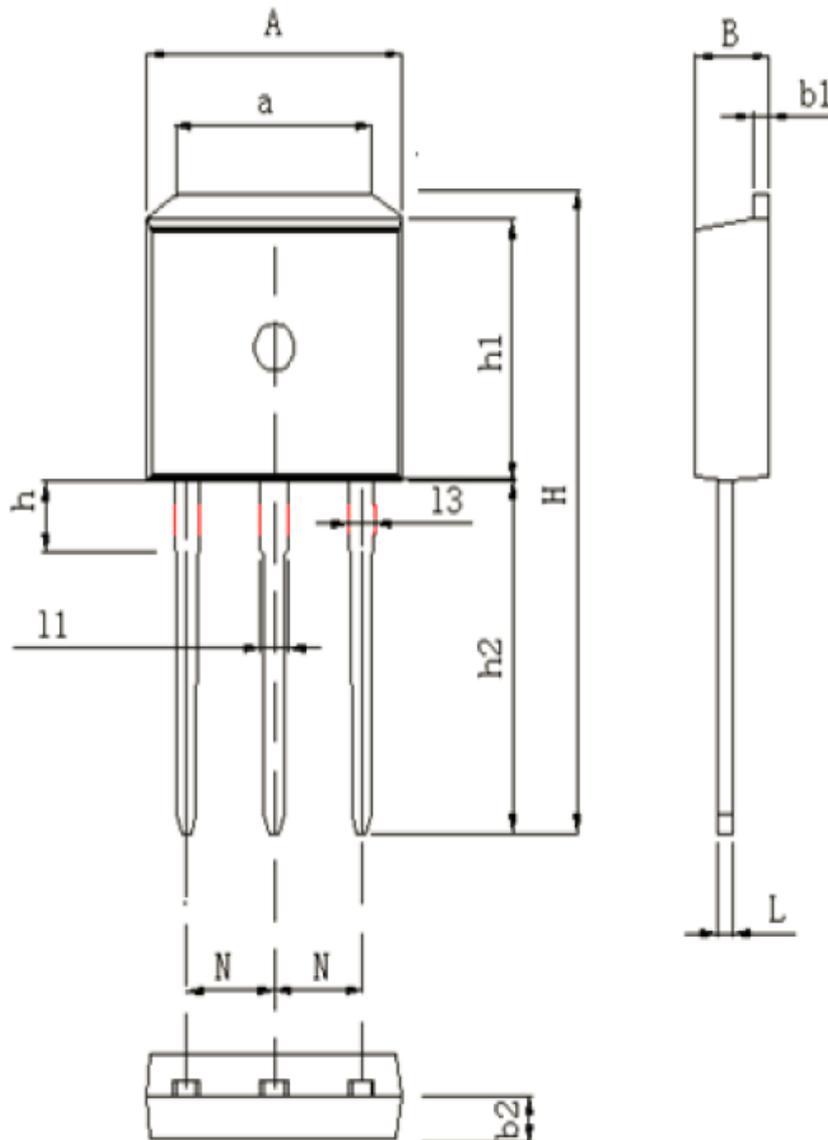
**TO-263**



Unit: mm		
Symbol	Min.	Max.
A	4.37	4.77
A1	1.22	1.42
A2	2.49	2.89
A3	0.00	0.25
b	0.70	0.96
b1	1.17	1.47
c	0.30	0.53
D1	8.50	8.90
D4	6.60	-

Unit: mm		
Symbol	Min.	Max.
E	9.86	10.36
E5	7.06	-
e	2.54BSC	
H	14.70	15.50
H2	1.07	1.47
L	2.00	2.60
L1	1.40	1.70
L4	0.25BSC	
θ	0°	9°

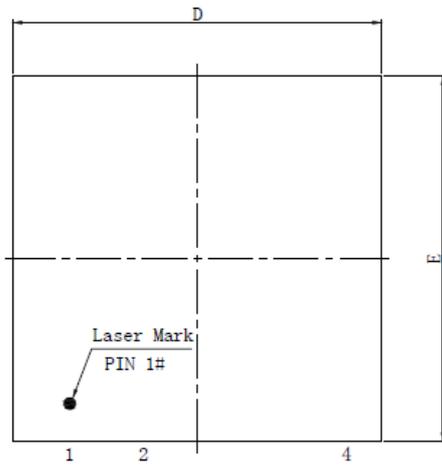
## TO-262



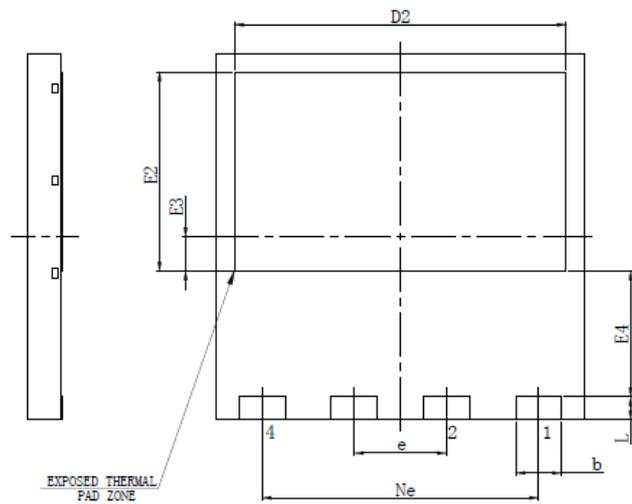
DIM	MILLIMETERS
A	$9.98 \pm 0.2$
a	$7.4 \pm 0.4$
B	$4.5 \pm 0.2$
b1	$1.3 \pm 0.05$
b2	$2.4 \pm 0.2$
H	$23.9 \pm 0.3$
h	$3.1 \pm 0.2$
h1	$9.16 \pm 0.2$
h2	$13.2 \pm 0.2$
L	$0.5 \pm 0.1$
11	$1.3 \pm 0.1$
12	$0.8 \pm 0.1$
N	$2.45 \pm 0.1$

Unit :mm

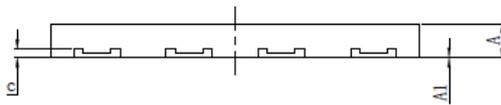
## DFN 8x8



TOP VIEW



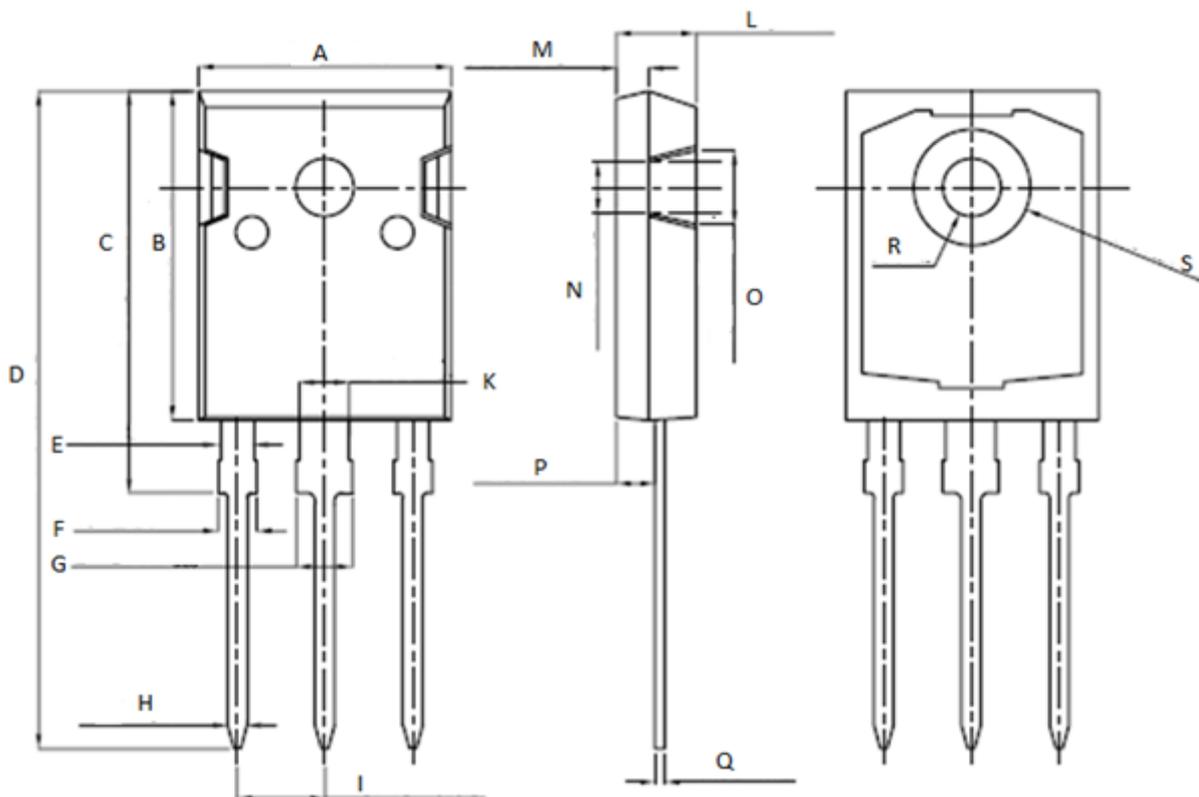
BOTTOM VIEW



SIDE VIEW

SYMBOL	MILLIMETER		
	MEN	NOM	MAX
A	0.70	0.75	0.80
A1	0	0.02	0.05
b	0.95	1.00	1.05
c	0.18	0.20	0.25
D	7.90	8.00	8.10
Ne	6.00BSC		
e	2.00BSC		
E	7.90	8.00	8.10
D2	7.10	7.20	7.30
E2	4.25	4.35	4.45
E3	0.75REF		
E4	2.75REF		
L	0.45	0.50	0.55
载体尺寸	7.60*5.15		

**TO-247**



Unit: mm		
Symbol	Min.	Max.
A	15.95	16.25
B	20.85	21.25
C	20.95	21.35
D	40.5	40.9
E	1.9	2.1
F	2.1	2.25
G	3.1	3.25
H	1.1	1.3
I	5.40	5.50

Unit: mm		
Symbol	Min.	Max.
K	2.90	3.10
L	4.90	5.30
M	1.90	2.10
N	4.50	4.70
O	5.40	5.60
P	2.29	2.49
Q	0.51	0.71
R	φ 3.5	φ 3.7
S	φ 7.1	φ 7.3

WPMtek reserves the right to make changes to the product specification and data in this document without notice. WPMtek makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does WPMtek assume any liability arising from the application or use of any products or circuits, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Any enquiry, please write to sales@wpmtek.com for further information.